

	Type	L #	Hits	Search Text	DBs	Time Stamp	Comments
1	BRS	L1	159	bergman-e\$.in.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB; USOCR	2004/08/17 08:18	
2	BRS	L2	89346	(clean or cleaning or cleaned or cleaner or cleanse or cleansing or cleansed or cleanser) with (semiconductor or wafer or substrate or workpiece)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB; USOCR	2004/08/17 08:19	
3	BRS	L3	18444 2	(treat or treating or treated or treatment) with (semiconductor or wafer or substrate or workpiece)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB; USOCR	2004/08/17 08:19	
4	BRS	L4	28734 2	(etch or etching or etched or etchant or strip or stripping stripped or stripper) with (semiconductor or wafer or substrate or workpiece)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB; USOCR	2004/08/17 08:20	
5	BRS	L5	35096	(immerse or immersing or immersed or immersion) with (semiconductor or wafer or substrate or workpiece)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB; USOCR	2004/08/17 08:20	
6	BRS	L6	19165	(rinse or rinsing or rinsed) with (semiconductor or wafer or substrate or workpiece)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB; USOCR	2004/08/17 08:21	
7	BRS	L7	31406 5	sonic or sonicate or sonication or sonicated or ultrasonic or ultrasonication or ultrasonicating or ultrasonicate or ultrasonicated or sonicating or megasonic or megasonicate or megasonicated or megasonicating	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB; USOCR	2004/08/17 08:23	

	Type	L #	Hits	Search Text	DBs	Time Stamp	Comments
8	BRS	L8	495695	12 or 13 or 14 or 15 or 16	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB; USOCR	2004/08/17 08:23	
9	BRS	L9	23617	18 and 17	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB; USOCR	2004/08/17 08:23	
10	BRS	L10	90534	(reduce or reducing or reduced or reduction or minimize or minimized or minimizing or lower or lowered or lowering or eliminate or eliminating or eliminated or elimination) adj10 (surface adj tension) or (surface adj tension\$ or surface adj tension adj gradient or Marangoni)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB; USOCR	2004/08/17 08:25	
11	BRS	L11	63577	(transfer or transferring or transferred or lift or lifting or lifted or withdraw or withdrawn or withdrawing or raise or raising or raised or remove or removing or removed) with (wafer or semiconductor or substrate or workpiece) with (tank or chamber or bath or solution)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB; USOCR	2004/08/17 08:28	
12	BRS	L12	8314	18 same 17	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB; USOCR	2004/08/17 08:29	
13	BRS	L13	115	112 same 110	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB; USOCR	2004/08/17 08:29	

	Type	L #	Hits	Search Text	DBs	Time Stamp	Comments
14	BRS	L15	49507	(134/\$).ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB; USOCR	2004/08/17 08:29	
15	BRS	L16	7	l14 and l1	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB; USOCR	2004/08/17 08:37	
16	BRS	L17	563	semitool\$.asn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB; USOCR	2004/08/17 08:37	
17	BRS	L18	7	l14 and l17	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB; USOCR	2004/08/17 08:37	
18	BRS	L14	57	l13 and l11	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB; USOCR	2004/08/17 09:32	
19	BRS	L19	10724 8	(134/\$ or 34/\$).ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB; USOCR	2004/08/17 09:33	
20	BRS	L20	53	l13 and l19	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB; USOCR	2004/08/17 09:33	
21	BRS	L21	2	6691720.pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB; USOCR	2004/08/17 09:34	

	Type	L #	Hits	Search Text	DBs	Time Stamp	Comments
22	BRS	L22	3	666844.pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB; USOCR	2004/08/17 09:36	
23	BRS	L23	2	6427359.pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB; USOCR	2004/08/17 09:34	
24	BRS	L24	7	121 or 122 or 123	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB; USOCR	2004/08/17 09:44	
25	BRS	L25	2	6668844.pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB; USOCR	2004/08/17 09:37	
26	BRS	L26	13	120 and (irradiate or irradiation or irradiating or irradiated)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB; USOCR	2004/08/17 09:37	
27	BRS	L27	14	("20030010352"   "20030010 362"   "4643774"   "4722752"   "4736759"   "4977688"   "50 90432"   "5301701"   "556933 0"   "5653045"   "5950645"   " 6299696"   "6427359"   "6502 591") .PN.	USPAT; US-PGPUB	2004/08/17 09:45	